



First Semiconductor

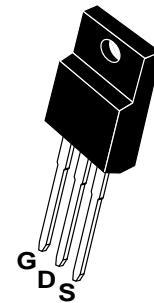
700V N-Channel MOSFET

FIR8N70FG

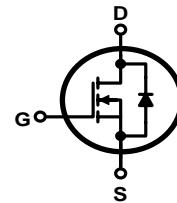
PIN Connection TO-220F

Features:

- Low Intrinsic Capacitances
- Excellent Switching Characteristics
- Extended Safe Operating Area
- Unrivalled Gate Charge : $Q_g = 22\text{nC}$ (Typ.)
- $V_{DSS}=700\text{V}, I_D=8\text{A}$
- $R_{DS(on)} : 1.2 \Omega$ (Max) @ $V_G=10\text{V}$
- 100% Avalanche Tested



Schematic diagram



Y	= Year
A	= Assembly Location
WW	= Work Week
VA	= Version & Assembly plant
FIR8N70F	= Specific Device Code

Absolute Maximum Ratings (Ta=25°C unless otherwise noted)

Symbol	Parameter		Value	Unit
V_{DSS}	Drain-Source Voltage		700	V
I_D	Drain Current	$T_c=25^\circ\text{C}$	8	A
		$T_c=100^\circ\text{C}$	5.2	
$V_{GS(TH)}$	Gate Threshold Voltage		± 30	V
E_{AS}	Single Pulse Avalanche Energy (note1)		540	mJ
I_{AR}	Avalanche Current (note2)		8	A
P_D	Power Dissipation ($T_c=25^\circ\text{C}$)		50	W
T_j	Junction Temperature(Max)		150	$^\circ\text{C}$
T_{stg}	Storage Temperature		-55~+150	$^\circ\text{C}$
TL	Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds		300	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JC}$	Thermal Resistance,Junction to Case	-	2.5	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance,Junction to Ambient	-	120	$^\circ\text{C}/\text{W}$



Electrical Characteristics $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ.	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{ID}=250 \mu\text{A}, \text{VGS}=0$	700	--	--	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	Breakdown Voltage Temperature Coefficient	$\text{I}_D=250 \mu\text{A}$, Reference to 25°C	--	0.77	--	$\text{V}/^\circ\text{C}$
IDSS	Zero Gate Voltage Drain Current	$\text{Vds}=700\text{V}, \text{Vgs}=0\text{V}$	--	--	10	μA
		$\text{Vds}=560\text{V}, \text{Tc}=125^\circ\text{C}$			100	μA
IGSSF	Gate-body leakage Current, Forward	$\text{Vgs}=+30\text{V}, \text{Vds}=0\text{V}$	--	--	100	nA
IGSSR	Gate-body leakage Current, Reverse	$\text{Vgs}=-30\text{V}, \text{Vds}=0\text{V}$	--	--	-100	nA

On Characteristics

$\text{V}_{\text{GS(th)}}$	Date Threshold Voltage	$\text{Id}=250\mu\text{A}, \text{Vds}=\text{Vgs}$	2	--	4	V
$\text{R}_{\text{DS(on)}}$	Static Drain-Source On-Resistance	$\text{Id}=4\text{A}, \text{Vgs}=10\text{V}$	--	0.95	1.2	Ω

Dynamic Characteristics

Ciss	Input Capacitance	$\text{VDS}=25\text{V}, \text{VGS}=0, f=1.0\text{MHz}$	--	1300	--	pF
Coss	Output Capacitance		--	135	--	pF
Crss	Reverse Transfer Capacitance		--	7.5	--	pF

Switching Characteristics

Td(on)	Turn-On Delay Time	$\text{VDD}=350\text{V}, \text{ID}=7.5\text{A}$ $\text{RG}=25\Omega$ (Note 3,4)	--	35	--	nS
Tr	Turn-On Rise Time		--	50	--	nS
Td(off)	Turn-Off Delay Time		--	120	--	nS
Tf	Turn-Off Fall Time		--	50	--	nS
Qg	Total Gate Charge	$\text{VDS}=560, \text{VGS}=10\text{V}, \text{ID}=7.5\text{A}$ (Note 3,4)	--	22	--	nC
Qgs	Gate-Source Charge		--	6.5	--	nC
Qgd	Gate-Drain Charge		--	6.5	--	nC

Drain-Source Diode Characteristics and Maximum Ratings

I_S	Maximum Continuous Drain-Source Diode Forward Current	--	--	8	A
I_{SM}	Maximum Plated Drain-Source Diode Forward Current	--	--	30	A
V_{SD}	Drain-Source Diode Forward Voltage	$\text{Id}=7.5\text{A}$	--	--	1.5 V
trr	Reverse Recovery Time	$\text{I}_S=7.5\text{A}, \text{V}_{\text{GS}}=0\text{V}$	--	370	-- nS
Qrr	Reverse Recovery Charge	$\text{di}_F/\text{dt}=100\text{A}/\mu\text{s}$ (Note 3)	--	3.3	-- μC

*Notes 1, $L=25.0\text{mH}$, $\text{IAS}=7.0\text{A}$, $\text{VDD}=50\text{V}$, $\text{RG}=25\Omega$, Starting $\text{TJ}=25^\circ\text{C}$

2, Repetitive Rating : Pulse width limited by maximum junction temperature

3, Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$

4, Essentially Independent of Operating Temperature

Typical Characteristics

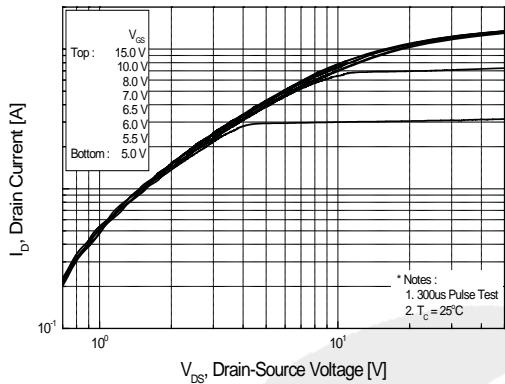


Figure 1. On Region Characteristics

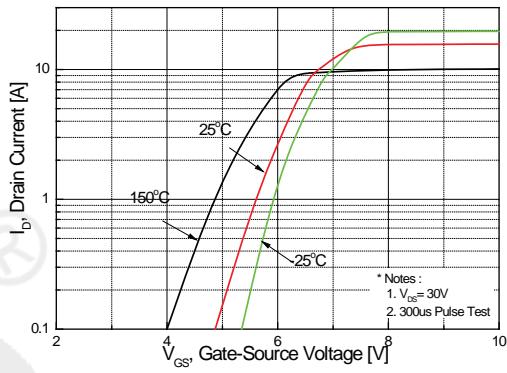


Figure 2. Transfer Characteristics

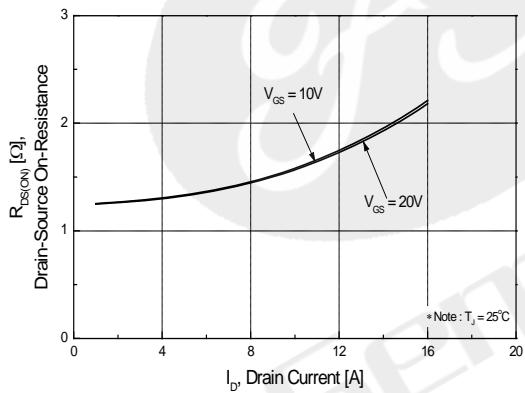


Figure 3. On Resistance Variation vs. Drain Current and Gate Voltage

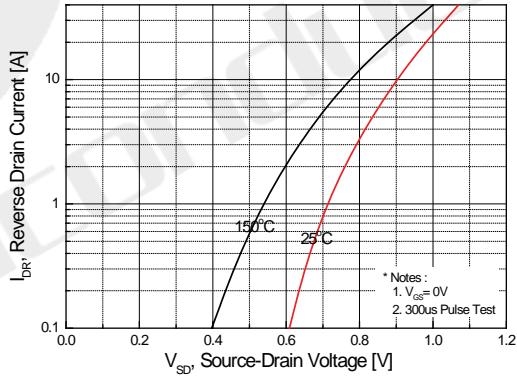


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

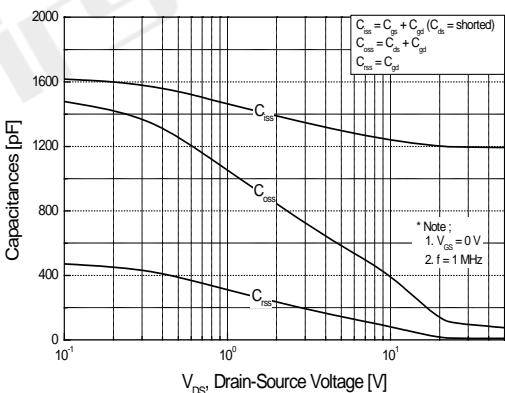


Figure 5. Capacitance Characteristics

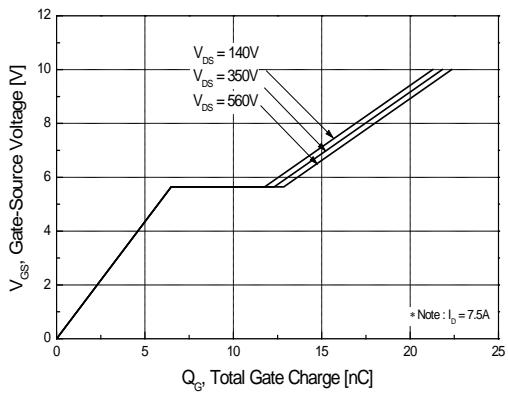


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

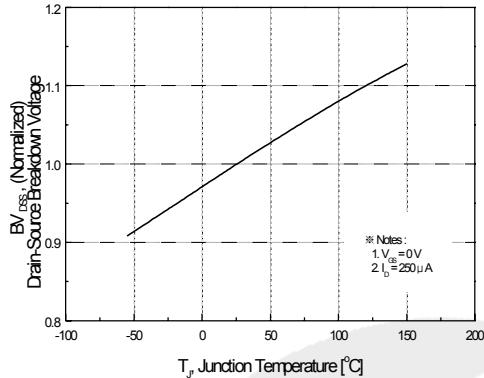


Figure 7. Breakdown Voltage Variation vs Temperature

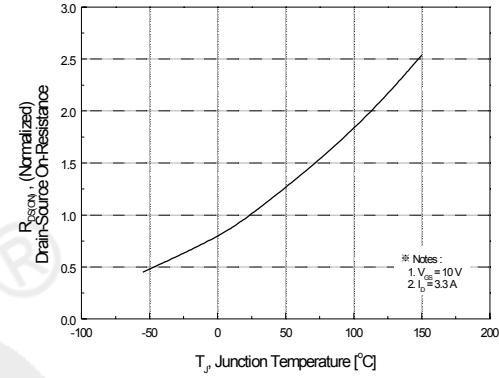


Figure 8. On-Resistance Variation vs Temperature

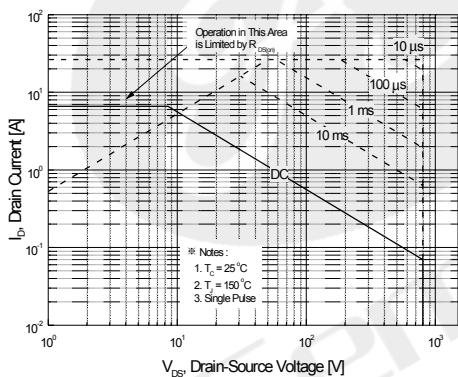


Figure 9-2. Maximum Safe Operating Area

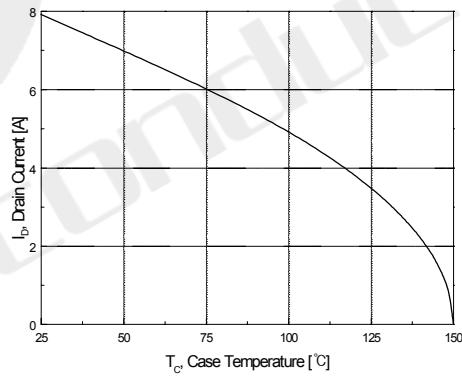


Figure 10. Maximum Drain Current vs Case Temperature

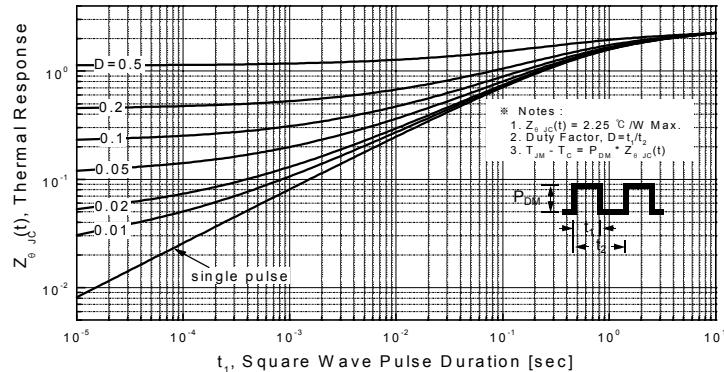
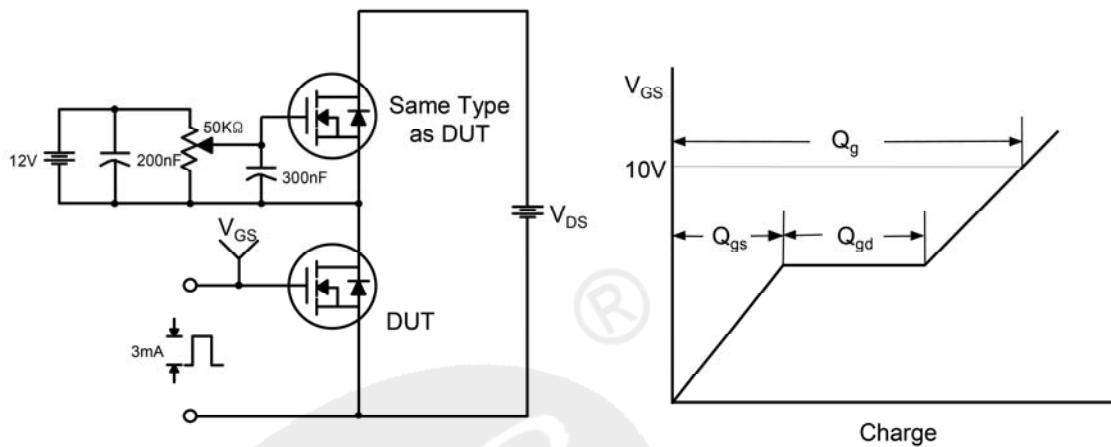
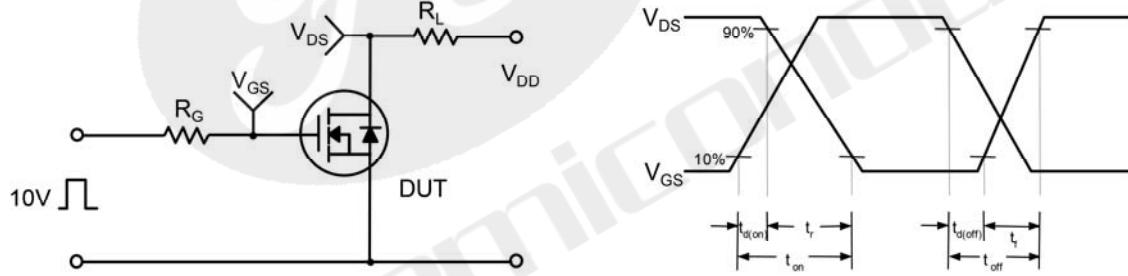


Figure 11-2. Transient Thermal Response Curve

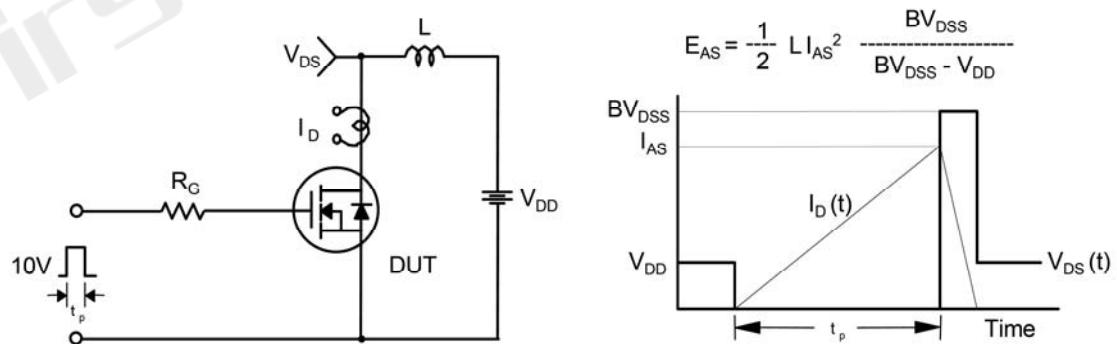
Gate Charge Test Circuit & Waveform



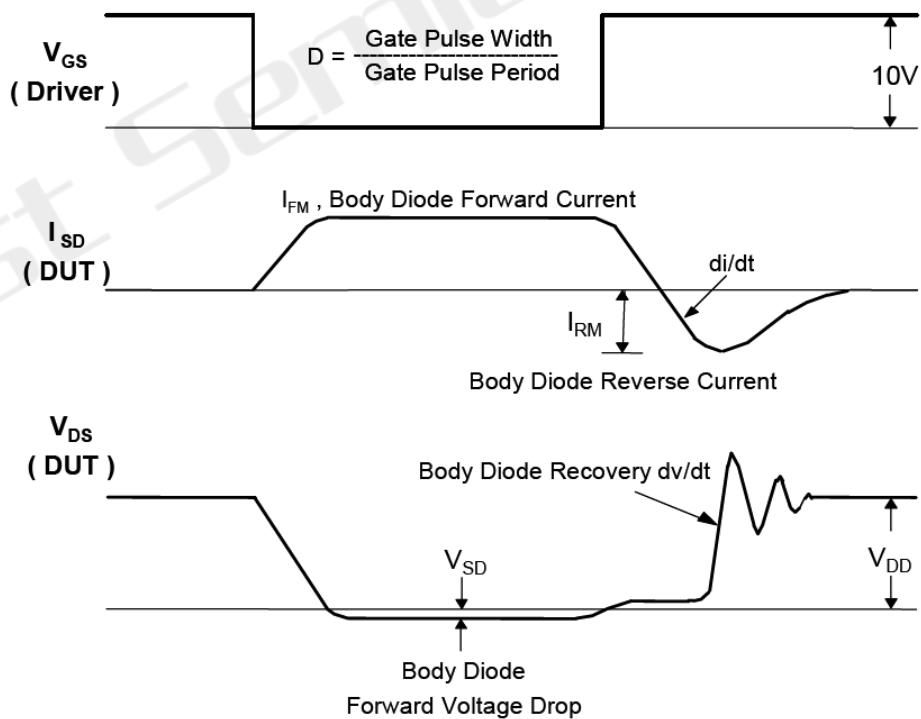
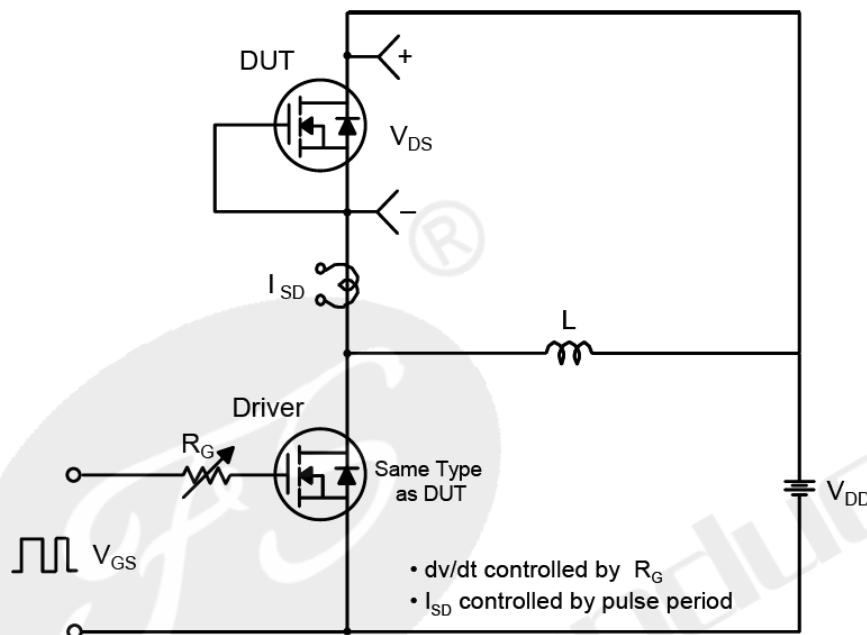
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

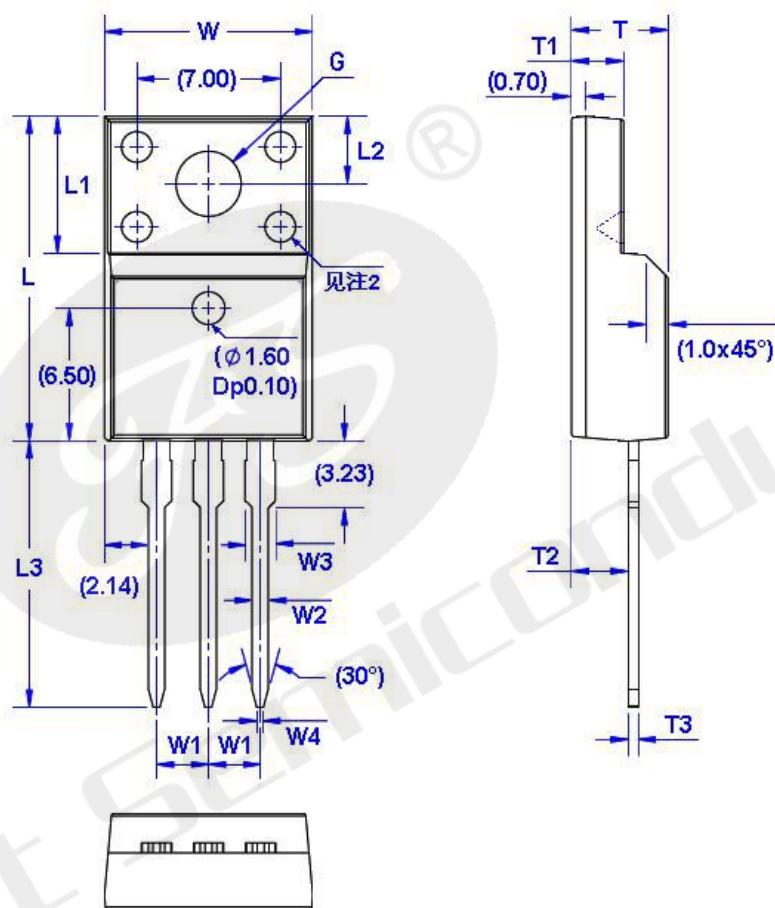


Peak Diode Recovery dv/dt Test Circuit & Waveform



Package Dimension
TO-220F

Unit: mm



Symbol	Size		Symbol	Size		Symbol	Size		Symbol	Size	
	Min	Max		Min	Max		Min	Max		Min	Max
W	9.96	10.36	W4	0.25	0.45	L3	12.78	13.18	T3	0.45	0.60
W1	2.54 (TYP)		L	15.67	16.07	T	4.50	4.90	G(Φ)	3.08	3.28
W2	0.70	0.90	L1	6.48	6.88	T1	2.34	2.74			
W3	1.24	1.47	L2	3.20	3.40	T2	2.56	2.96			



Declaration

- FIRST reserves the right to change the specifications, the same specifications of products due to different packaging line mold, the size of the appearance will be slightly different, shipped in kind, without notice! Customers should obtain the latest version information before ordering, and verify whether the relevant information is complete and up-to-date.
- Any semiconductor product under certain conditions has the possibility of failure or failure, The buyer has the responsibility to comply with safety standards and take safety measures when using FIRST products for system design and manufacturing, To avoid potential failure risks, which may cause personal injury or property damage!
- Product promotion endless, our company will wholeheartedly provide customers with better products!

ATTACHMENT

Revision History

Date	REV	Description	Page
2018.01.01	1.0	Initial release	